

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MITSUHISA WATANABE	12/25/2015
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
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DATE SIGNED:	08/22/2018
Total Attachments: 2	
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ASSIGNMENT BY INVENTOR

This Assignment is by Mitsuhsa Watanabe, having a mailing address of c/o Micron Akita, Inc, 89-2, Yamada, Yuwaishida, Akita-shi, Akita, 010-1222 Japan (the "Assignor").

The Assignor invented one or more certain inventions (the "Invention(s)") described in an application for Letters Patent of the United States titled STACKED SEMICONDUCTOR DIES WITH SELECTIVE CAPILLARY UNDER FILL, naming the Assignor as inventor, and filed on _____ as U.S. Application No. _____ (the "Application"). The Assignor authorizes the Assignee, identified below, or its representatives to insert the application number and filing date of the Application when known.

Micron Technology, Inc., a corporation of Delaware having its principal place of business at 8000 S. Federal Way, P.O. Box 6, Boise, Idaho 83707-0006 ("Assignee"), desires to acquire the entire right, title and interest in and to the Invention(s) and the Application, and in and to any patents (collectively, "Patents") that may be granted for the Invention(s) in the United States or in any foreign countries.

For valuable consideration, the receipt and sufficiency of which Assignor acknowledges, Assignor hereby sells, assigns, and transfers to Assignee, its successors, legal representatives and assigns, the entire right, title and interest in and to: the Invention(s), the Application, and any Patents; any divisions, continuations, and continuations-in-part of the Application and any other application claiming priority rights from the Application; any reissues, reexaminations, or extensions of any and all Patents; the right to file foreign applications directly in the name of Assignee; and the right to claim priority rights deriving from the Application (collectively, the "Rights"). Assignor warrants that Assignor owns the Rights, and that the Rights are unencumbered. Assignor also agrees to not sign any writing or do any act conflicting with this assignment, and, without further compensation, sign all documents and do such additional acts as Assignee deems necessary or desirable to: perfect Assignee's enjoyment of the Rights; conduct proceedings regarding the Rights, including any litigation or interference proceedings; or perfect or defend title to the Rights.

Date: 2015.12.25

Mitsuhisa Watanabe
Mitsuhisa Watanabe

Witness:

Shoko Tomita
Printed Name

Shoko Tomita
Signature

Witness:

Miku Takemasa
Printed Name

Miku Takemasa
Signature